

KLT-W4MF-OV5640 V1.0 NIR

5MP OmniVision OV5640 MIPI Interface No IR Filter Fixed Focus Camera Module



Front View



Back View

Specifications

Camera Module No.	KLT-W4MF-OV5640 V1.0 NIR
Resolution	5MP
Image Sensor	OV5640
Sensor Type	1/4"
Pixel Size	1.4 um x 1.4 um
EFL	2.34 mm
F.NO	2.40
Pixel	2592 x 1944
View Angle	87.9°(DFOV) 75.3°(HFOV) 59.8°(VFOV)
Lens Dimensions	8.50 x 8.50 x 4.12 mm
Module Size	73.30 x 48.10 mm
Module Type	Fixed Focus
Interface	MIPI
Auto Focus VCM Driver IC	Embedded
Lens Model	KLT-LENS-40103A1
Lens Type	No IR Filter Lens
Operating Temperature	-30°C to +70°C
Mating Connector	AXK740147G

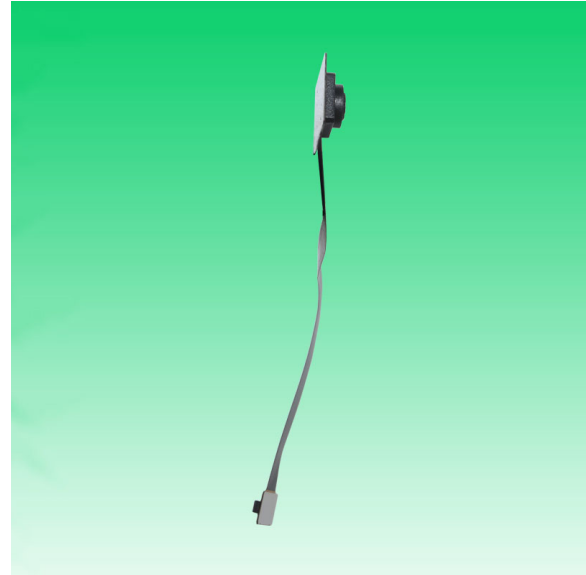


KLT-W4MF-OV5640 V1.0 NIR

5MP OmniVision OV5640 MIPI Interface No IR Filter Fixed Focus Camera Module



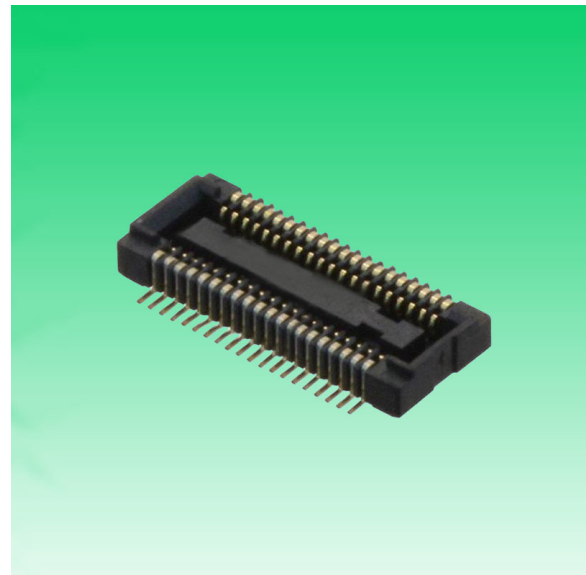
Top View



Side View



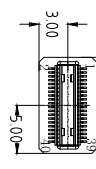
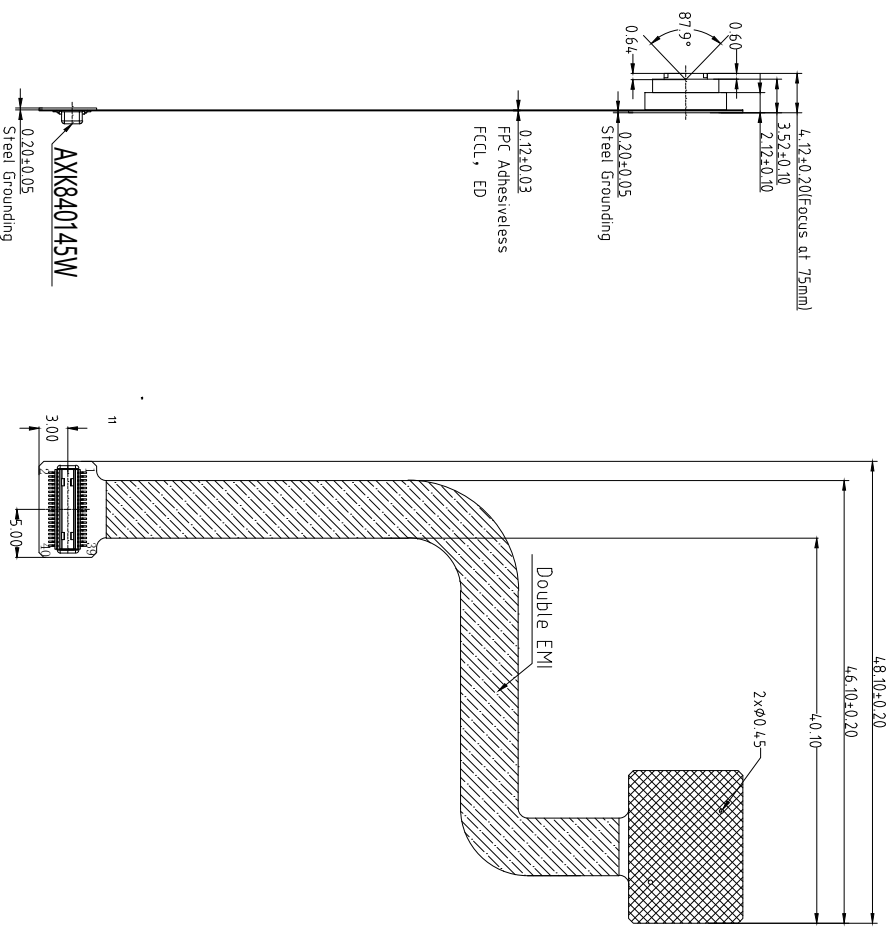
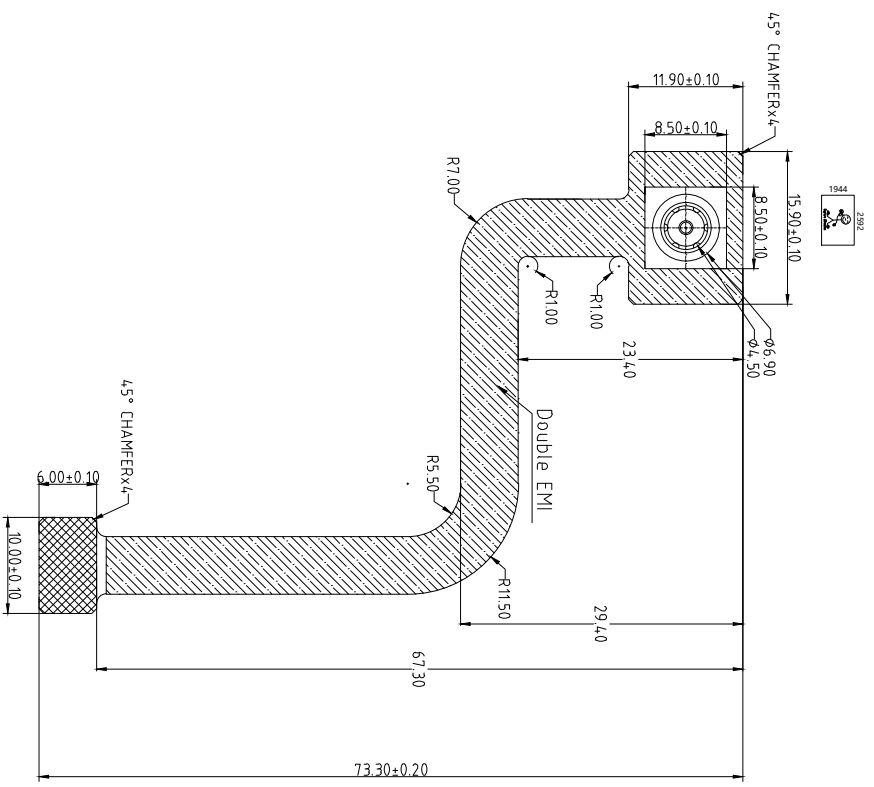
Bottom View



Mating Connector

D		E	
Version	Information	Date	
V1.0	First Version	12-12-2020	

A		B		C		D		E	
ROHS		PIN		SIGNAL					
1	GND								
2	GND								
3	MCP								
4	NC								
5	MCN								
6	NC								
7	GND								
8	NC								
9	MDP0								
10	NC								
11	MDN0								
12	1V8/DOVDD								
13	GND								
14	1V8/DOVDD								
15	MDP1								
16	NC								
17	MDN1								
18	NC								
19	GND								
20	GND								
21	SIOD								
22	NC								
23	SI0C								
24	GND								
25	GND								
26	PWDN								
27	XCLK								
28	RESET								
29	GND								
30	NC								
31	NC								
32	GND								
33	GND								
34	NC								
35	1V5/DVDD								
36	GND								
37	1V5/DVDD								
38	2V8/AVDD								
39	1V5/DVDD								
40	2V8/AVDD								



Kai Lap Technologies Group Ltd

Designed By Kevin Model Name: KLT-W4MF-0V5640 V1.0 NIR

Checked By Aouly_Yan Projection Type: Third Angle Unit: mm Material: Scale: 1:1 Sheet: 1 of 1 Version: 1/0

2、 Lens specification:

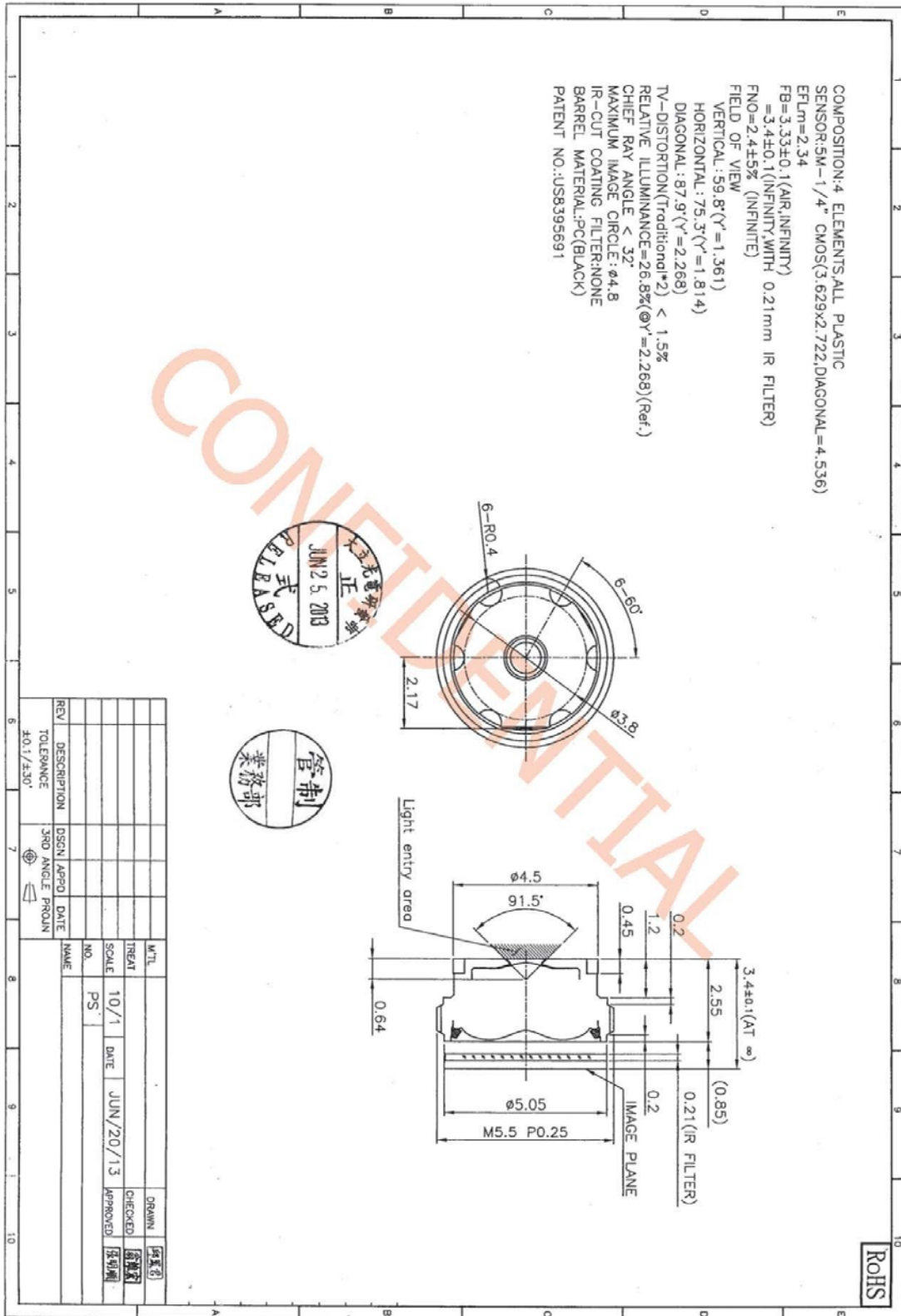
FOV: 87.9°(D),75.3°(H),59.8°(V)
 F/NO.: 2.4
 TV distortion: <1.5%
 Focal length: 2.34mm
 Composition: 4P

Parameter:

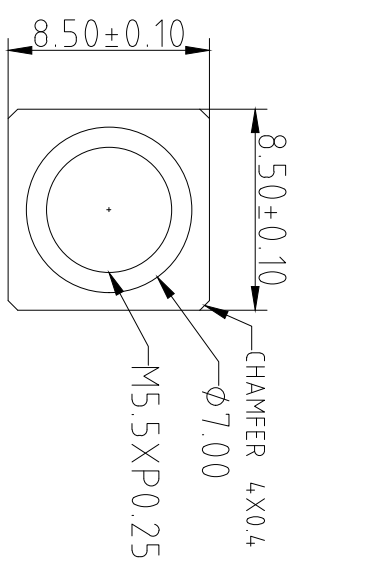
1、 Sensor specification:
 Image Sensor: OV5640
 Pixel: 1.4umx1.4um
 Lens Type: 1/4
 Important Voltage Description: DVDD1.5V
 (external power supply);



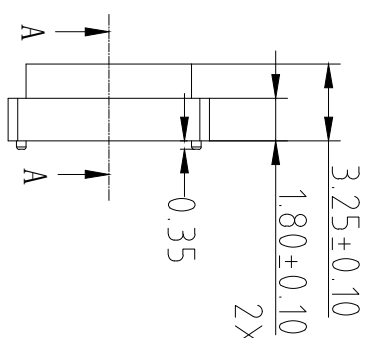
Lens Model: KLT-LENS-40103A1



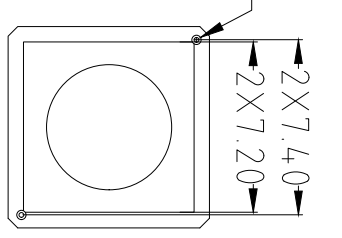
Version	Information	Date
V1.0	First Version	1-10-2022



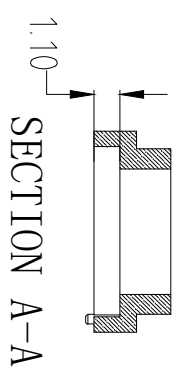
TOP VIEW



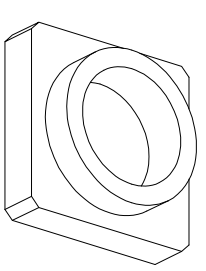
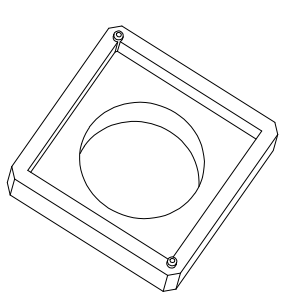
SIDE VIEW



BOTTOM VIEW



SECTION A-A



Kai Lap Technologies Group Ltd

Designed By

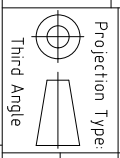
Kevin

Model Name:

KLT-PKNZ3858B

Checked By

Aouly_Yan



Unit: mm

Scale: 1:1

Sheet: 1 of 1

Version: 1/0

A	B	C	D
1	2	3	1
A	B	C	D
1	2	3	1

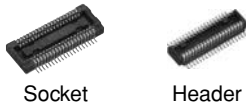
Panasonic
ideas for life

NARROW-PITCH CONNECTORS FOR BOARD-TO-BOARD AND BOARD-TO-FPC CONNECTION

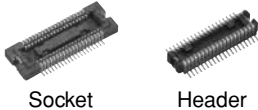
NARROW PITCH (0.4mm) CONNECTORS P4 SERIES



• Without retention fitting



• With retention fitting

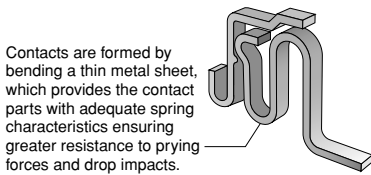


FEATURES

1. 0.4 mm pitch and support for mated heights of up to 1.5 mm, 2.0 mm, 2.5 mm, 3.0 mm, 3.5 mm, and 4.0 mm.

2. Strong resistance to adverse environments! Utilizes **TOUGH CONTACT** construction for high contact reliability.

1) Contacts are highly resistant to shock caused by dropping and employ our original bellows contact construction.



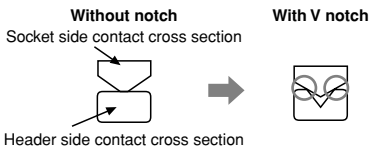
Contacts are formed by bending a thin metal sheet, which provides the contact parts with adequate spring characteristics ensuring greater resistance to prying forces and drop impacts.

2) V notch construction used for excellent resistance against foreign matters.

● What is V notch construction?

By using the edge for the contacting part and increasing contact pressure per unit area, the effectiveness in removing flux and contaminants is increased compared to its predecessor. This is also effective in preventing the trapping of contaminants.

[Cross section of contacting part]

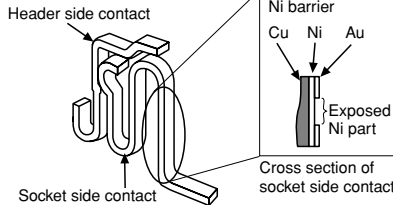


3) Use of Ni barrier construction is standard. Highly effective against solder creeping.

● What is Ni barrier construction?

By providing an exposed nickel part on the gold (Au) plated contact, solder creeping is prevented despite the ultra low profile.

[Contact]

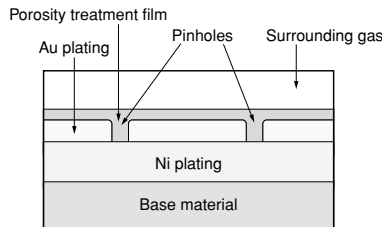


Note: Construction makes solder creeping difficult because header side is formed at the same time.

4) Porosity treatment applied for improved resistance against corrosion.

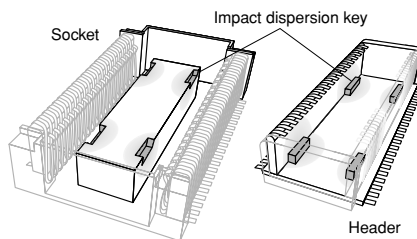
What is porosity treatment?

This treatment consists of coating the surface with a very thin film to seal pinholes in the gold plating. This porosity treatment technology ensures the same contact reliability for thin gold plating as that of thick gold plating.



- Improvement in insertion/removal durability
- Improvement in resistance to corrosion
- Improvement in contact reliability for digital signals

3. It is constructed with impact dispersion keys inside the body to disperse shocks when dropped.

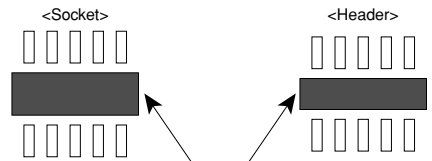


A high level of shock resistance is ensured by dispersing impact over the four locations where the socket indentations and header protrusions are mated together.

Note: The following numbers of contacts are not supported due to suction surface factors.

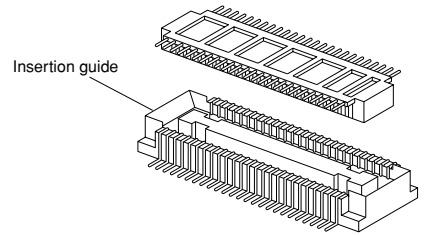
- Without retention fitting: 18 contacts or less
 - With retention fitting: 22 contacts or less
4. Construction makes designing devices easier.

1) The lower connector bottom surface construction prevents contact and shorts between the PCB and metal terminals. This enables freedom in pattern wiring, helping to make PCB's smaller.

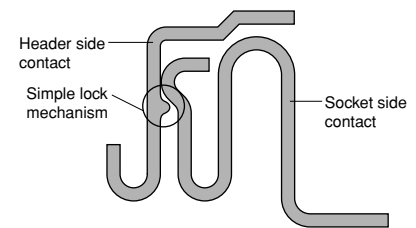


Connector bottom: Create any thru-hole and pattern wiring.

2) Guides are provided to take up any position shift and facilitate insertion.



3) The connector has a simple lock mechanism. Superior mated operation with click feel to indicate that mated is complete.



5. Design makes efficient mounting. Features a terminal flatness of 0.08 mm, construction resistant to creeping flux, and design that facilitates visual inspection of the soldered part.

6. Compliance with RoHS Directive Environmentally friendly, the connectors comply with Europe's RoHS Directive. Cadmium, lead, mercury, hexavalent chromium, PBB and PBDE are not used.

7. Connectors for inspection available Connectors for inspection are available that are ideal for modular unit inspection and inspection in device assembly processes.

APPLICATIONS

Compact portable devices “Cellular phones, DVC, Digital cameras, etc”

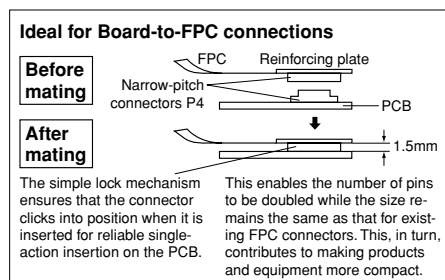
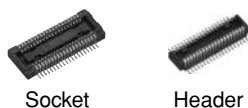


TABLE OF PRODUCT TYPES

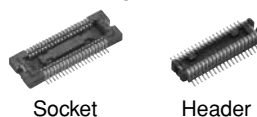
P4 (0.4 mm pitch): Without retention fitting



☆: Available for sale

Mated height	Number of contacts					
	1.5mm	2.0mm	2.5mm	3.0mm	3.5mm	4.0mm
14	☆	☆	☆			
16	☆					
20	☆	☆	☆			
22	☆					
24	☆	☆	☆			
26	☆	☆				
28	☆					
30	☆	☆	☆			
34	☆	☆				
36	☆					
40	☆	☆	☆			
44	☆		☆			
50	☆	☆	☆			
54	☆					
60	☆		☆			
64	☆					
70	☆	☆	☆			
80	☆	☆				
90	☆		☆			
100	☆	☆	☆			

P4 (0.4 mm pitch): With retention fitting



☆: Available for sale

Mated height	Number of contacts					
	1.5mm	2.0mm	2.5mm	3.0mm	3.5mm	4.0mm
10	☆					
12	☆					
20	☆		☆	☆	☆	
22	☆					
24		☆				
28	☆					
30	☆					
32			☆			
34	☆					☆
40	☆		☆	☆		
44	☆					
46	☆					
50	☆		☆	☆	☆	☆
60	☆		☆	☆	☆	
80	☆	☆	☆	☆	☆	☆
90	☆		☆	☆		
100	☆					

Note: Please contact us regarding numbers of contacts other than those given above.

AXK7, 8

ORDERING INFORMATION

AXK

7: Narrow Pitch Connector P4 (0.4 mm pitch) Socket
8: Narrow Pitch Connector P4 (0.4 mm pitch) Header

Number of contacts (2 digits)

Mated height
<Socket>
1: For mated height 1.5 mm
2: For mated height 2.0 mm
3: For mated height 2.5 mm and 3.0 mm
4: For mated height 3.5 mm
5: For mated height 4.0 mm
<Header>
1: For mated height 1.5 mm, 2.0 mm and 2.5 mm
2: For mated height 3.0 mm, 3.5 mm and 4.0 mm

Functions
1: With retention fitting, with positioning bosses
2: With retention fitting, without positioning bosses
3: Without retention fitting, with positioning bosses
4: Without retention fitting, without positioning bosses

Surface treatment (Contact portion / Terminal portion)
<Socket>
5: Ni plating on base, Au plating on surface
7: Ni plating on base, Au plating on surface (for Ni barrier product available)
<Header>
5: Ni plating on base, Au plating on surface

Other specifications
<Header>
Y: V notch type product
W: V notch and post edge horseshoe bend type product Note*

Packing
G: 3,000 pieces embossed tape and plastic reel × 2*

Note:
The post edge horseshoe bend indicated by the "W" in the tenth digit of the header part number refers to a construction that makes it difficult for the header post edge to deform when the connector is inserted and removed at an angle.

* Only a socket of mated height 3.5 mm and 4.0 mm: 2,000 pieces embossed tape and plastic reel × 2.

PRODUCT TYPES

1. Without retention fitting 

Mated height	Number of contacts	Part number			Packing	
		Socket	Header		Inner carton	Outer carton
		<i>TOUGH CONTACT</i>	<i>TOUGH CONTACT</i>	<i>TOUGH CONTACT</i> and Post edge horseshoe bend type (Recommendation)		
1.5 mm	14	AXK714147G	AXK814145YG	AXK814145WG	3,000 pieces	6,000 pieces
	16	AXK716147G	AXK816145YG	AXK816145WG		
	20	AXK720147G	AXK820145YG	AXK820145WG		
	22	AXK722147G	AXK822145YG	AXK822145WG		
	24	AXK724147G	AXK824145YG	AXK824145WG		
	26	AXK726147G	AXK826145YG	AXK826145WG		
	28	AXK728147G	AXK828145YG	AXK828145WG		
	30	AXK730147G	AXK830145YG	AXK830145WG		
	34	AXK734147G	AXK834145YG	AXK834145WG		
	36	AXK736147G	AXK836145YG	AXK836145WG		
	40	AXK740147G	AXK840145YG	AXK840145WG		
	44	AXK744147G	AXK844145YG	AXK844145WG		
	50	AXK750147G	AXK850145YG	AXK850145WG		
	54	AXK754147G	AXK854145YG	AXK854145WG		
	60	AXK760147G	AXK860145YG	AXK860145WG		
	64	AXK764147G	AXK864145YG	AXK864145WG		
	70	AXK770147G	AXK870145YG	AXK870145WG		
	80	AXK780147G	AXK880145YG	AXK880145WG		
90	AXK790147G	AXK890145YG	AXK890145WG			
100	AXK700147G	AXK800145YG	AXK800145WG			
2.0 mm	14	AXK714247G	AXK814145YG	AXK814145WG	3,000 pieces	6,000 pieces
	20	AXK720247G	AXK820145YG	AXK820145WG		
	24	AXK724247G	AXK824145YG	AXK824145WG		
	26	AXK726247G	AXK826145YG	AXK826145WG		
	30	AXK730247G	AXK830145YG	AXK830145WG		
	34	AXK734247G	AXK834145YG	AXK834145WG		
	40	AXK740247G	AXK840145YG	AXK840145WG		
	50	AXK750247G	AXK850145YG	AXK850145WG		
	70	AXK770247G	AXK870145YG	AXK870145WG		
	100	AXK700247G	AXK800145YG	AXK800145WG		
2.5 mm	14	AXK714347G	AXK814145YG	AXK814145WG	3,000 pieces	6,000 pieces
	20	AXK720347G	AXK820145YG	AXK820145WG		
	24	AXK724347G	AXK824145YG	AXK824145WG		
	30	AXK730347G	AXK830145YG	AXK830145WG		
	40	AXK740347G	AXK840145YG	AXK840145WG		
	44	AXK744347G	AXK844145YG	AXK844145WG		
	50	AXK750347G	AXK850145YG	AXK850145WG		
	60	AXK760347G	AXK860145YG	AXK860145WG		
	70	AXK770347G	AXK870145YG	AXK870145WG		
	90	AXK790347G	AXK890145YG	AXK890145WG		
100	AXK700347G	AXK800145YG	AXK800145WG			

- Notes: 1. Regarding ordering units; During production: Please make orders in 1-reel units.
 Samples for mounting confirmation: Available in units of 50 pieces. Please consult us. (See "Regarding sample orders to confirm proper mounting" on page 13.)
 Samples: Small lot orders are possible.
2. The standard type comes without positioning bosses. Connectors with positioning bosses are available on-demand production. For this type of connector, 8th digit of the part number changes from 4 to 3. e.g. Mated height 1.5 mm and 20 contacts for socket without retention fitting: AXK720137G
3. The 10th digit "Y" in the header part number indicates the connector has V notch. (For details, please refer to page 36.)
 "W" indicates a product with V notch and post edge horseshoe bend. ("Post edge horseshoe bend" refers to a construction that makes it difficult for the header post edge to deform when the connector is inserted and removed at an angle.)
 "Products with V notch" and "products with V notch and post edge horseshoe bend" are mating compatible.
4. Connectors of different mated height (3.0 mm, 3.5 mm and 4.0 mm) and different number of contacts are available on-demand production only. Please contact us for more details.

SPECIFICATIONS

1. Characteristics

	Item	Specifications	Conditions
Electrical characteristics	Rated current	0.3A/contact (Max. 5 A at total contacts)	
	Rated voltage	60V AC/DC	
	Breakdown voltage	150V AC for 1 min.	Detection current: 1mA
	Insulation resistance	Min. 1,000M Ω (initial)	Using 250V DC megger (applied for 1 min.)
	Contact resistance	Max. 70m Ω	Measured based on the HP4338B measurement method of JIS C 5402
Mechanical characteristics	Composite insertion force	Max. 0.981N {100gf}/contacts \times contacts (initial)	
	Composite removal force	Min. 0.0588N {6gf}/contacts \times contacts (Mated height 1.5 mm, without removal and retention fitting) Min. 0.118N {12gf}/contacts \times contacts (Mated height 1.5 mm, except without removal and retention fitting)	
	Post holding force	Min. 0.981N {100gf}/contacts	Measures the maximum load in the post axial direction until removal
Environmental characteristics	Ambient temperature	-55°C to +85°C	No freezing at low temperatures
	Soldering heat resistance	Max. peak temperature of 245°C	Infrared reflow soldering
		300°C within 5 sec. 350°C within 3 sec.	Soldering iron
	Thermal shock resistance (header and socket mated)	5 cycles, insulation resistance min. 100M Ω , contact resistance max. 70m Ω	Sequence 1. -55 \pm 3°C, 30 minutes 2. ~, Max. 5 minutes 3. 85 \pm 3°C, 30 minutes 4. ~, Max. 5 minutes
	Humidity resistance (header and socket mated)	120 hours, insulation resistance min. 100M Ω , contact resistance max. 70m Ω	Bath temperature 40 \pm 2°C, humidity 90 to 95% R.H.
	Saltwater spray resistance (header and socket mated)	24 hours, insulation resistance min. 100M Ω , contact resistance max. 70m Ω	Bath temperature 35 \pm 2°C, saltwater concentration 5 \pm 1%
Lifetime characteristics	Insertion and removal life	50 times	Repeated insertion and removal speed of max. 200 times/hours

2. Material and surface treatment

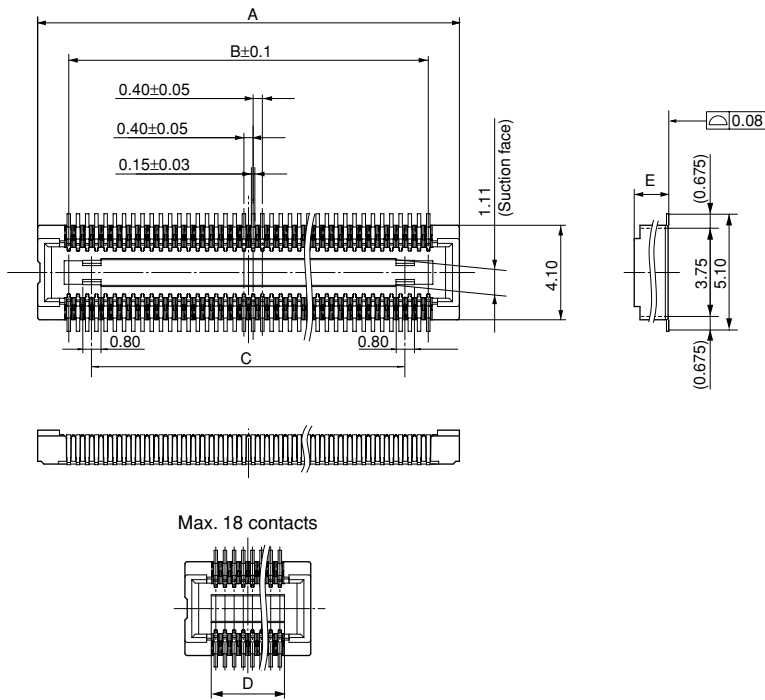
Part name	Material	Surface treatment
Molded portion	Heat-resistant resin (UL94V-0), Black	—
Contact and Post	Copper alloy	Contact portion: Ni plating on base, Au plating on surface Terminal portion: Ni plating on base, Au plating on surface (Except for thick of terminal) However, upper terminal of Ni barrier production: Exposed over Ni The area adjacent to the terminal of the sockets on models with Ni barrier is exposed to Ni on base.
Retention fitting portion	Copper alloy	Ni plating on base, Sn plating on surface (Except for front terminal)

AXK7, 8

DIMENSIONS (mm)

1. Without Retention Fitting

Socket (Mated height: 1.5 mm, 2.0 mm, and 2.5 mm)



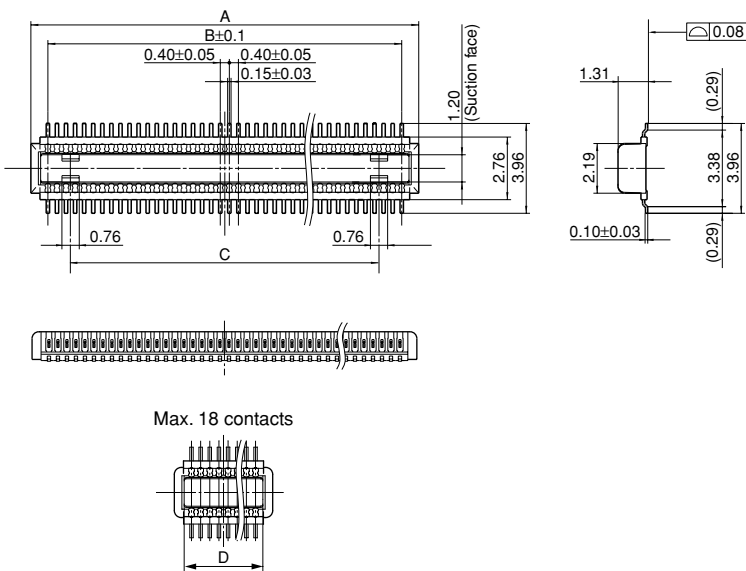
General tolerance: ± 0.2

Dimension table (mm)

Number of contacts/ dimension	A	B	C	D
14	5.1	2.4	—	2.8
16	5.5	2.8	—	3.2
20	6.3	3.6	1.6	—
22	6.7	4.0	2.0	—
24	7.1	4.4	2.4	—
26	7.5	4.8	2.8	—
28	7.9	5.2	3.2	—
30	8.3	5.6	3.6	—
34	9.1	6.4	4.4	—
36	9.5	6.8	4.8	—
40	10.3	7.6	5.6	—
44	11.1	8.4	6.4	—
50	12.3	9.6	7.6	—
54	13.1	10.4	8.4	—
60	14.3	11.6	9.6	—
64	15.1	12.4	10.4	—
70	16.3	13.6	11.6	—
80	18.3	15.6	13.6	—
90	20.3	17.6	15.6	—
100	22.3	19.6	17.6	—

Mated height/dimension	E
1.5mm	1.50
2.0mm	1.92
2.5mm	2.42

Header (Mated height: 1.5 mm, 2.0 mm, and 2.5 mm "products with V notch")

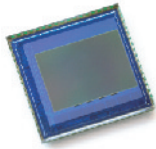


General tolerance: ± 0.2

Dimension table (mm)

Number of contacts/ dimension	A	B	C	D
14	3.9	2.4	—	3.04
16	4.3	2.8	—	3.44
20	5.1	3.6	1.6	—
22	5.5	4.0	2.0	—
24	5.9	4.4	2.4	—
26	6.3	4.8	2.8	—
28	6.7	5.2	3.2	—
30	7.1	5.6	3.6	—
34	7.9	6.4	4.4	—
36	8.3	6.8	4.8	—
40	9.1	7.6	5.6	—
44	9.9	8.4	6.4	—
50	11.1	9.6	7.6	—
54	11.9	10.4	8.4	—
60	13.1	11.6	9.6	—
64	13.9	12.4	10.4	—
70	15.1	13.6	11.6	—
80	17.1	15.6	13.6	—
90	19.1	17.6	15.6	—
100	21.1	19.6	17.6	—

Note: "Products with V notch" and "products with V notch and post edge horseshoe bend" are mating compatible.



OV5640 5-megapixel product brief



1/4-inch, 5-Megapixel SOC Image Sensor Optimized for High-Volume Mobile Markets



available in
a lead-free
package

The OV5640 delivers a complete 5-megapixel camera solution on a single chip, aimed at offering cost efficiencies that serve the high-volume autofocus (AF) camera phone market. The system-on-a-chip (SOC) sensor features OmniVision's 1.4 micron OmniBSI™ backside illumination architecture to deliver excellent pixel performance and best-in-class low-light sensitivity, while enabling ultra compact camera module designs of 8.5 mm x 8.5 mm with <6 mm z-height. The OV5640 provides the full functionality of a complete camera, including anti-shake technology, AF control, and MIPI while being easier to tune than two-chip solutions, making it an ideal choice in terms of cost, time-to-market and ease of platform integration.

The OV5640 enables 720p HD video at 60 frames per second (fps) and 1080p HD video at 30 fps with complete user control over formatting and output data transfer. The 720p/60 HD video is captured in full field of view (FOV) with 2 x 2 binning, which doubles the sensitivity and improves the signal-to-noise ratio (SNR). Additionally, a unique post-binning re-sampling filter function removes zigzag artifacts around slant edges and minimizes spatial artifacts to deliver even sharper, crisper

color images. To further improve camera performance and user experience, the OV5640 features an internal anti-shake engine for image stabilization, and it supports Scalado™ tagging for faster image preview and zoom.

The OV5640 offers a digital video port (DVP) parallel interface and a high-speed dual lane MIPI interface, supporting multiple output formats. An integrated JPEG compression engine simplifies data transfer for bandwidth-limited interfaces. The sensor's automatic image control functions include automatic exposure control (AEC), automatic white balance (AWB), automatic band filter (ABF), 50/60 Hz automatic luminance detection, and automatic black level calibration (ABLC). The OV5640 delivers programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning. It also offers color saturation, hue, gamma, sharpness (edge enhancement), lens correction, defective pixel canceling, and noise canceling to improve image quality.

Find out more at www.ovt.com.

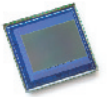
Applications

- Mobile Phones
- Entertainment
- Digital Still and Video Cameras

Product Features

- 1.4 μm x 1.4 μm pixel with OmniBSI technology for high performance (high sensitivity, low crosstalk, low noise, improved quantum efficiency)
- optical size of 1/4"
- automatic image control functions:
 - automatic exposure control (AEC)
 - automatic white balance (AWB)
 - automatic band filter (ABF)
 - automatic 50/60 Hz luminance detection
 - automatic black level calibration (ABLCL)
- programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning
- image quality controls: color saturation, hue, gamma, sharpness (edge enhancement), lens correction, defective pixel canceling, and noise canceling
- support for output formats: RAW RGB, RGB565/555/444, CCIR656, YUV422/420, YCbCr422, and compression
- support for LED and flash strobe mode
- support for internal and external frame synchronization for frame exposure mode
- support horizontal binning and vertical sub-sampling
- support horizontal binning and vertical sub-sampling
- post binning resampling filter to minimize spatial/aliasing artifacts on 2x2 binned image
- embedded JPEG compression
- support for anti-shake
- digital video port (DVP) parallel output interface and dual lane MIPI output interface
- embedded 1.5V regulator for core power
- programmable I/O drive capability, I/O tri-state configurability
- support for black sun cancellation
- embedded arbitrary scalar supporting any size from 5 MP and below
- auto focus control (AFC) with embedded AF VCM driver
- embedded microcontroller
- suitable for module size of 8.5 x 8.5 x ~6mm with both CSP and RW packaging

OV5640



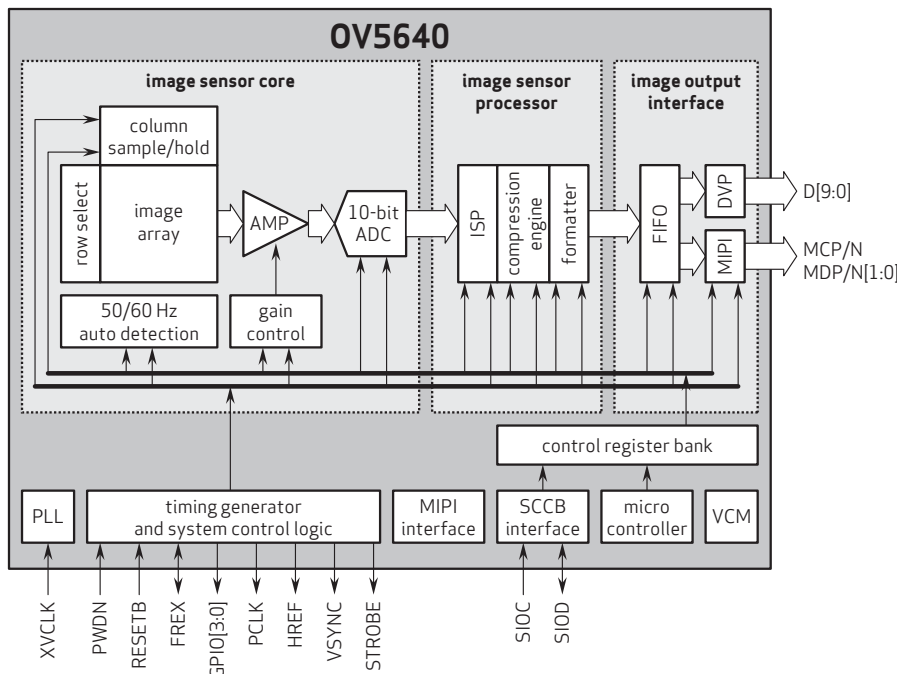
Ordering Information

- **OV05640-A71A**
(color, lead-free, 71-pin CSP3)
- **OV05640-G04A**
(color, chip probing, 200 μm backgrinding, reconstructed wafer)

Product Specifications

- **active array size:** 2592 x 1944
- **power supply:**
 - core: 1.5 V $\pm 5\%$ (with embedded 1.5 V regulator)
 - analog: 2.6 - 3.0 V (2.8 V typical)
 - I/O: 1.8 V / 2.8 V
- **power requirements:**
 - active: 140 mA
 - standby: 20 μA
- **temperature range:**
 - operating: -30°C to 70°C junction temperature
 - stable image: 0°C to 50°C junction temperature
- **output formats:** 8/10-bit RAW RGB output
- **lens size:** 1/4"
- **lens chief ray angle:** 24°
- **input clock frequency:** 6 - 27 MHz
- **shutter:** rolling shutter / frame exposure
- **maximum image transfer rate:**
 - QSXGA (2592x1944): 15 fps
 - 1080p: 30 fps
 - 1280 x 960: 45 fps
 - 720p: 60 fps
 - VGA (640x480): 90 fps
 - QVGA (320x240): 120 fps
- **sensitivity:** 600 mV/lux-sec
- **maximum exposure interval:** 1964 x t_{row}
- **max S/N ratio:** 36 dB
- **dynamic range:** 68 dB @ 8x gain
- **pixel size:** 1.4 μm x 1.4 μm
- **dark current:** 8 mV/sec @ 60°C junction temperature
- **image area:** 3673.6 μm x 2738.4 μm
- **package dimensions:**
 - CSP3: 5985 μm x 5835 μm
 - COB: 6000 μm x 5850 μm

Functional Block Diagram



4275 Burton Drive
Santa Clara, CA 95054
USA

Tel: + 1 408 567 3000
Fax: + 1 408 567 3001
www.ovt.com

OmniVision reserves the right to make changes to their products or to discontinue any product or service without further notice. OmniVision, the OmniVision logo and OmniPixel are registered trademarks of OmniVision Technologies, Inc. OmniBSI is a trademark of OmniVision Technologies, Inc. All other trademarks are the property of their respective owners.

OmniVision



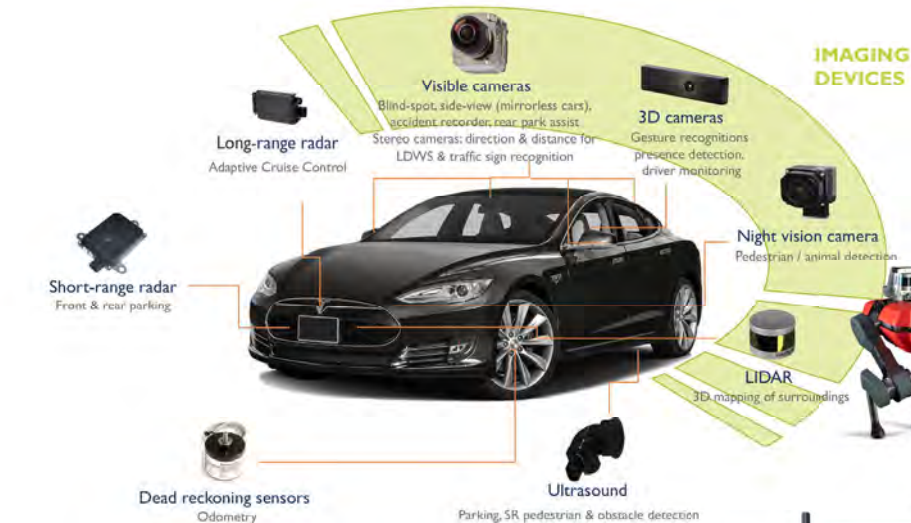
Camera Module Pinout Definition Reference Chart

OmniVision	Sony	Samsung	On-Semi	Aptina	Himax	GalaxyCore	PixArt	SmartSens	Sensors
Pin Signal									
Description									
DGND	GND								
AGND									
PCLK	DCK								
XCLR	PWDN	XSHUTDOWN	STANDBY						
MCLK	XVCLK	XCLK	INCK						
RESET	RST								
NC	NULL								
SDA	SIO_D	SIOD							
SCL	SIO_C	SIOC							
VSYNC	XVS	FSYNC							
HREF	XHS								
DOVDD									
AFVDD									
AVDD									
DVDD									
STROBE	FSTROBE								
FSIN									
SID									
ILPWM									
FREX									
GPIO									
SLASEL									
AFEN									
MIPI Interface									
MDN0	DN0	MD0N	DATA_N	DMO1N					
MDP0	DP0	MD0P	DATA_P	DMO1P					
MDN1	DN1	MD1N	DATA2_N	DMO2N					
MDP1	DP1	MD1P	DATA2_P	DMO2P					
MDN2	DN2	MD2N	DATA3_N	DMO3N					
MDP2	DP2	MD2P	DATA3_P	DMO3P					
MDN3	DN3	MD3N	DATA4_N	DMO4N					
MDP3	DP3	MD3P	DATA4_P	DMO4P					
MCN	CLKN	CLK_N	DCKN						
MCP	CLKP	MCP	CLK_P	DCKN					
DVP Parallel Interface									
D0	DO0	Y0							
D1	DO1	Y1							
D2	DO2	Y2							
D3	DO3	Y3							
D4	DO4	Y4							
D5	DO5	Y5							
D6	DO6	Y6							
D7	DO7	Y7							
D8	DO8	Y8							
D9	DO9	Y9							
D10	DO10	Y10							
D11	DO11	Y11							



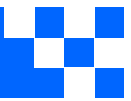
your BEST camera module partner

Cameras Applications



IMAGING DEVICES





Camera Reliability Test

Reliability Inspection Item		Testing Method	Acceptance Criteria	
Category	Item			
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional



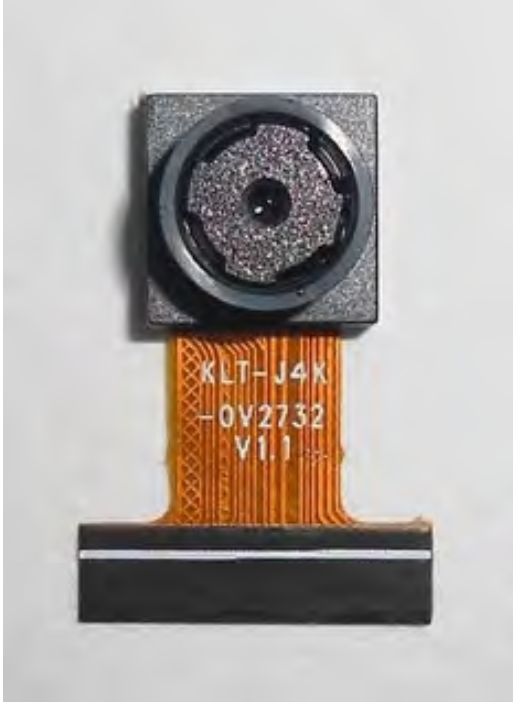


Inspection Item		Inspection Method	Standard of Inspection		
Category	Item				
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.	
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Gap	The Naked Eye	Meet the Height Standard	
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard	
		Contamination	The Naked Eye	No Effect On Resolution Standard	
		Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
	Function	Image	No Communication	Test Board	Not Allowed
			Bright Pixel	Black Board	Not Allowed In the Image Center
Dark Pixel			White board	Not Allowed In the Image Center	
Blurry			The Naked Eye	Not Allowed	
No Image			The Naked Eye	Not Allowed	
Vertical Line			The Naked Eye	Not Allowed	
Horizontal Line			The Naked Eye	Not Allowed	
Light Leakage			The Naked Eye	Not Allowed	
Blinking Image			The Naked Eye	Not Allowed	
Bruise			Inspection Jig	Not Allowed	
Resolution			Chart	Follows Outgoing Inspection Chart Standard	
Color			The Naked Eye	No Issue	
Noise			The Naked Eye	Not Allowed	
Corner Dark			The Naked Eye	Less Than 100px By 100px	
Color Resolution			The Naked Eye	No Issue	
Dimension	Height	The Naked Eye	Follows Approval Data Sheet		
	Width	The Naked Eye	Follows Approval Data Sheet		
	Length	The Naked Eye	Follows Approval Data Sheet		
	Overall	The Naked Eye	Follows Approval Data Sheet		



KLT Package Solutions

KLT Camera Module



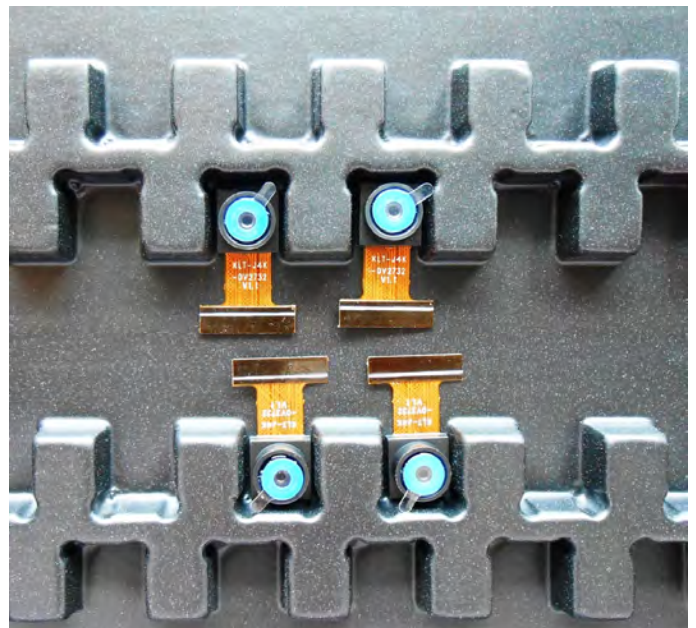
Complete with Lens Protection Film



Tray with Grid and Space



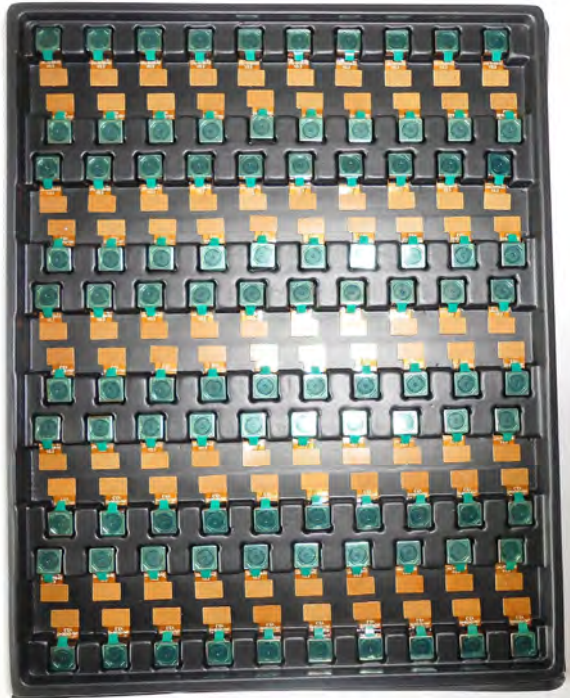
Place Cameras on the Tray





Camera Modules Package Solution

Full Tray of Cameras



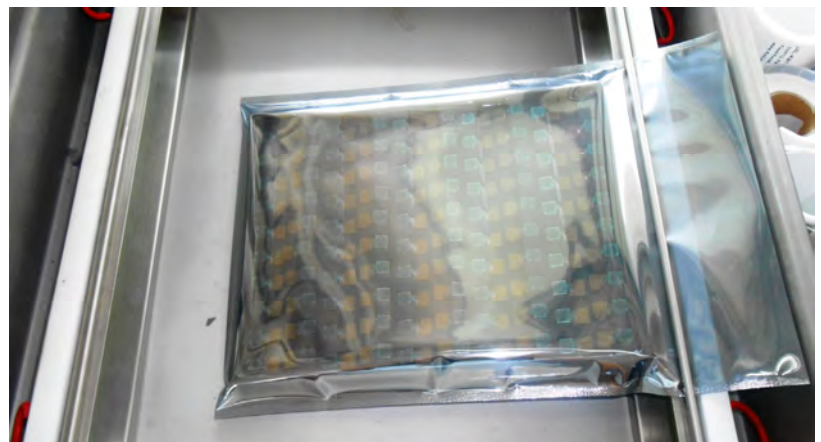
Cover Tray with Lid



Put Tray into Anti-Static Bag



Vacuum the Anti-Static Bag





Camera Modules Package Solution

Sealed Vacuum Bag with Labels

1. Model and Description 2. Quantity 3. Shipping Date 4. Caution





Large Order Package Solution

Place Foam Sheets Between Trays



Foam Sheets are Slightly Larger than Trays



Place Foam Sheets and Trays into Box



Foam Sheets are Tightly Fitting Box





Small Order Package Solution

Place Foam Sheets and Trays into Small Box



Foam Sheets are Nicely Fitting the Small Box



Package in Small Box for Shipment



Place Small Boxes into Larger Box





Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box



Carbon Box Ready for Shipment

1. Delivery Address and Phone No. 2. Box No. and Ship Date 3. Fragile Caution





Sample Order Package Solution

Place Sample into Small Anti-Static Bag



Place Connectors into Small Ant-Static Bag



Sample Labels on the Small Bag

1. Camera Module or Connector Model 2. Shipping Date and Quantity 3. Caution





Connectors Large Order Package Solution

Connectors in a Wheel



Label Connectors in the Wheel



The Wheel is Perfectly Fitting the Box



Connectors Box Ready for Shipment

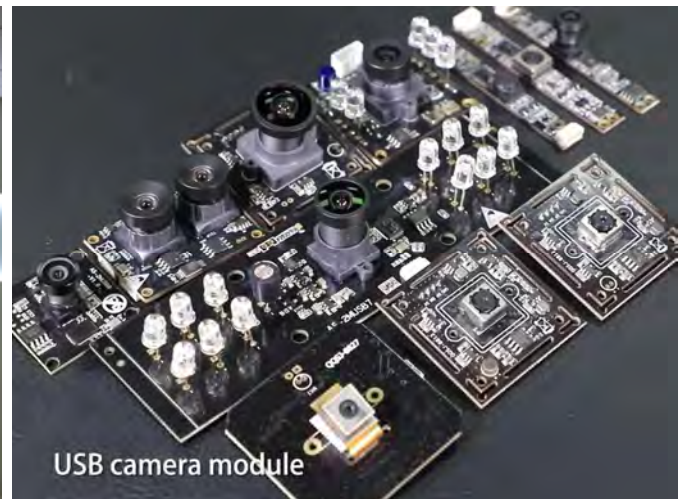


Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, www.KaiLapTech.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequent events.





CMOS CAMERA MODULES



your BEST camera module partner

KLT Strength

Powerful Factory



Professional Service



Promised Delivery



www.KaiLapTech.com sales@KaiLapTech.com Tel: (852) 6908 1256 Fax: (852) 3017 6778

All rights reserved @ Kai Lap Technologies Group Ltd. Specifications subject to change without notice.